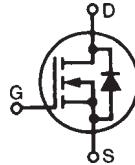


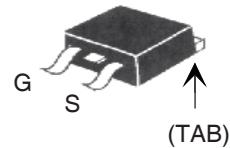
**TrenchHV™  
Power MOSFET**
**IXTA42N15T  
IXTP42N15T**

**V<sub>DSS</sub>** = 150V  
**I<sub>D25</sub>** = 42A  
**R<sub>DS(on)</sub>** ≤ 45mΩ

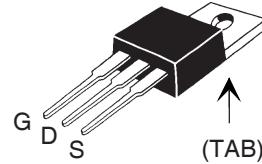
N-Channel Enhancement Mode  
Avalanche Rated



TO-263



TO-220



G = Gate      D = Drain  
 S = Source      TAB = Drain

Symbol	Test Conditions	Maximum Ratings		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 175°C	150		V
V <sub>DGR</sub>	T <sub>J</sub> = 25°C to 175°C, R <sub>GS</sub> = 1MΩ	150		V
V <sub>GSM</sub>	Transient	± 30		V
I <sub>D25</sub>	T <sub>C</sub> = 25°C	42		A
I <sub>DM</sub>	T <sub>C</sub> = 25°C, pulse width limited by T <sub>JM</sub>	100		A
I <sub>A</sub>	T <sub>C</sub> = 25°C	5		A
E <sub>AS</sub>	T <sub>C</sub> = 25°C	400	mJ	
P <sub>D</sub>	T <sub>C</sub> = 25°C	200		W
T <sub>J</sub>		-55 ... +175		°C
T <sub>JM</sub>		175		°C
T <sub>stg</sub>		-55 ... +175		°C
T <sub>L</sub>	1.6mm (0.062in.) from case for 10s	300		°C
T <sub>SOLD</sub>	Plastic body for 10 seconds	260		°C
M <sub>d</sub>	Mounting torque (TO-220)	1.13 / 10	Nm/lb.in.	
Weight	TO-263	2.5	g	
	TO-220	3.0	g	

Symbol	Test Conditions (T <sub>J</sub> = 25°C unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	150		V
V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	2.5		V
I <sub>GSS</sub>	V <sub>GS</sub> = ± 20V, V <sub>DS</sub> = 0V			±100 nA
I <sub>DSS</sub>	V <sub>DS</sub> = V <sub>DSS</sub> V <sub>GS</sub> = 0V			5 μA
		T <sub>J</sub> = 150°C		150 μA
R <sub>DS(on)</sub>	V <sub>GS</sub> = 10V, I <sub>D</sub> = 0.5 • I <sub>D25</sub> , Notes 1, 2	38	45	mΩ

### Features

- International standard packages
- 175°C Operating Temperature
- Avalanche rated

### Advantages

- Easy to mount
- Space savings
- High power density

### Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor drives
- Uninterruptible power supplies
- High speed power switching applications

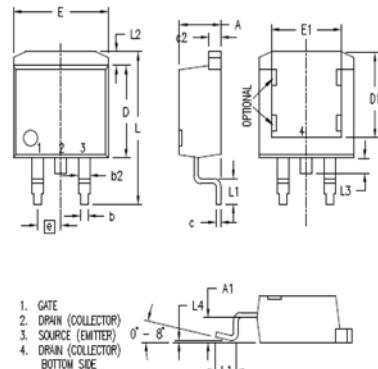
Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 10\text{V}$ , $I_D = 0.5 \cdot I_{D25}$ , Note 1	20	33	S
$C_{iss}$		1880		pF
$C_{oss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 25\text{V}$ , $f = 1\text{MHz}$	255		pF
$C_{rss}$		37		pF
$t_{d(on)}$	<b>Resistive Switching Times</b> $V_{GS} = 15\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$ $R_G = 10\Omega$ (External)	14		ns
$t_r$		16		ns
$t_{d(off)}$		50		ns
$t_f$		25		ns
$Q_{g(on)}$		21		nC
$Q_{gs}$	$V_{GS} = 10\text{V}$ , $V_{DS} = 0.5 \cdot V_{DSS}$ , $I_D = 0.5 \cdot I_{D25}$	6.0		nC
$Q_{gd}$		6.6		nC
$R_{thJC}$			0.75	$^\circ\text{C}/\text{W}$
$R_{thCH}$	TO-220	0.50		$^\circ\text{C}/\text{W}$

### Source-Drain Diode

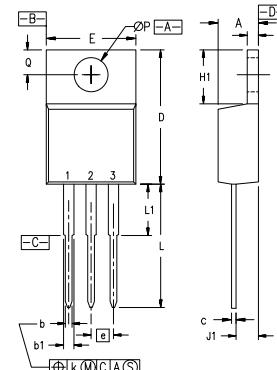
Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$I_s$	$V_{GS} = 0\text{V}$		42	A
$I_{sm}$	Repetitive, Pulse width limited by $T_{JM}$		126	A
$V_{SD}$	$I_F = 21\text{A}$ , $V_{GS} = 0\text{V}$ , Note 1		1.1	V
$t_{rr}$	$I_F = 25\text{A}$ , $V_{GS} = 0\text{V}$ , $-di/dt = 100\text{A}/\mu\text{s}$ , $V_R = 50\text{V}$	100		ns

Notes:

1. Pulse test,  $t \leq 300\mu\text{s}$ ; duty cycle,  $d \leq 2\%$ .
2. On through-hole packages,  $R_{DS(on)}$  Kelvin test contact location must be 5mm or less from the package body.

**TO-263 (IXTA) Outline**


SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.160	.190	4.06	4.83
A1	.080	.110	2.03	2.79
b	.020	.039	0.51	0.99
b2	.045	.055	1.14	1.40
c	.016	.029	0.40	0.74
c2	.045	.055	1.14	1.40
D	.340	.380	8.64	9.65
D1	.315	.350	8.00	8.89
E	.380	.410	9.65	10.41
E1	.245	.320	6.22	8.13
e	.100	BSC	2.54	BSC
L	.575	.625	14.61	15.88
L1	.090	.110	2.29	2.79
L2	.040	.055	1.02	1.40
L3	.050	.070	1.27	1.78
L4	0	.005	0	0.13

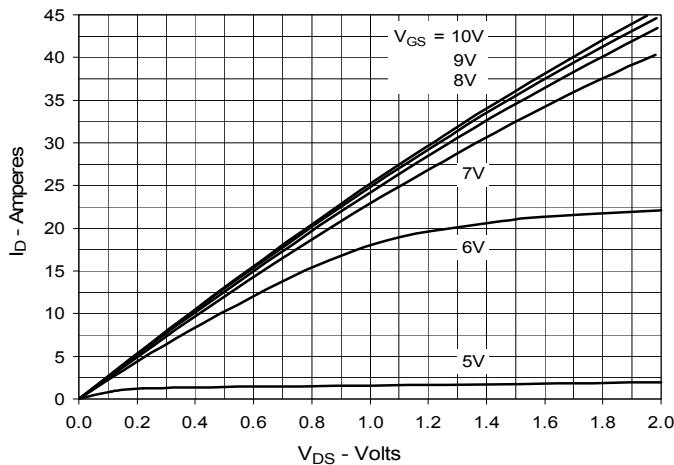
**TO-220 (IXTP) Outline**

Pins:  
1 - Gate  
3 - Source  
2 - Drain  
4 - Drain

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.170	.190	4.32	4.83
b	.025	.040	0.64	1.02
b1	.045	.065	1.15	1.65
c	.014	.022	0.35	0.56
D	.580	.630	14.73	16.00
E	.390	.420	9.91	10.66
e	.100	BSC	2.54	BSC
F	.045	.055	1.14	1.40
H1	.230	.270	5.85	6.85
J1	.090	.110	2.29	2.79
k	0	.015	0	0.38
L	.500	.550	12.70	13.97
L1	.110	.230	2.79	5.84
OP	.139	.161	3.53	4.08
Q	.100	.125	2.54	3.18

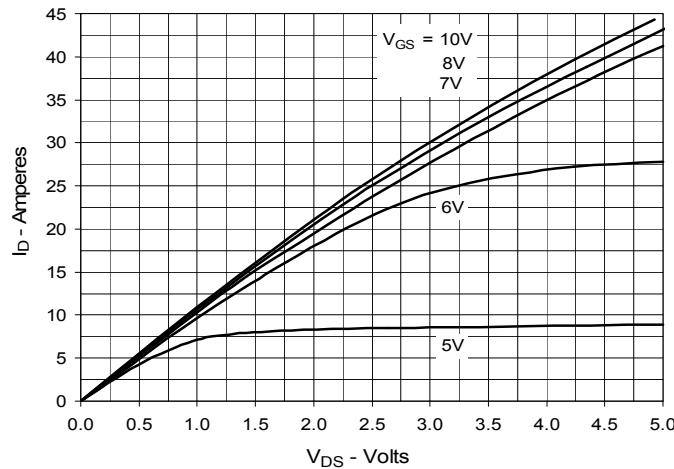
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 7,005,734 B2 7,157,338B2 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405 B2 6,759,692 7,063,975 B2 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2 7,071,537

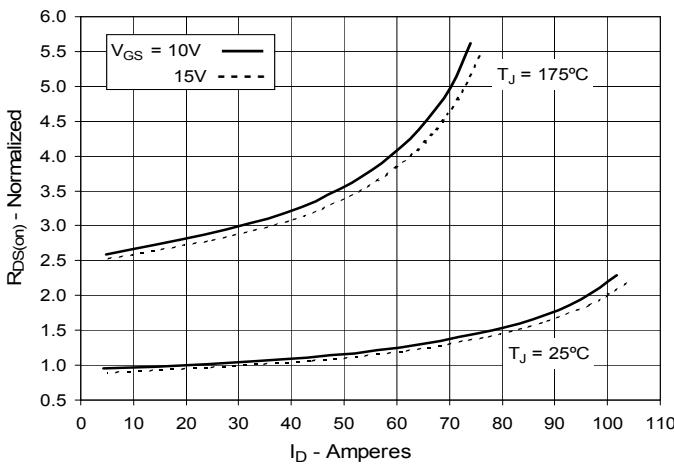
**Fig. 1. Output Characteristics  
@ 25°C**



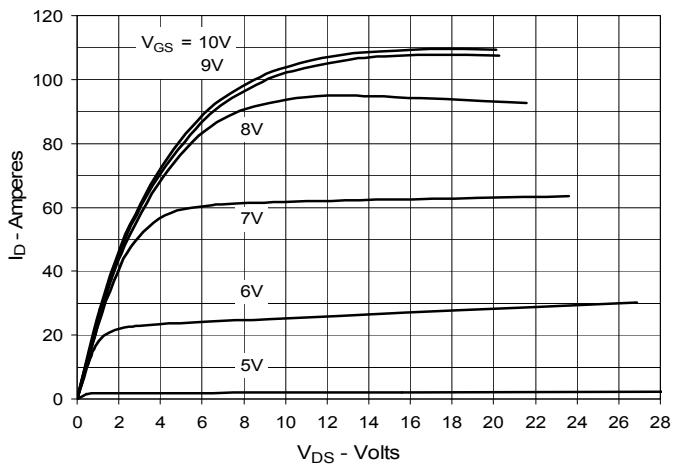
**Fig. 3. Output Characteristics  
@ 150°C**



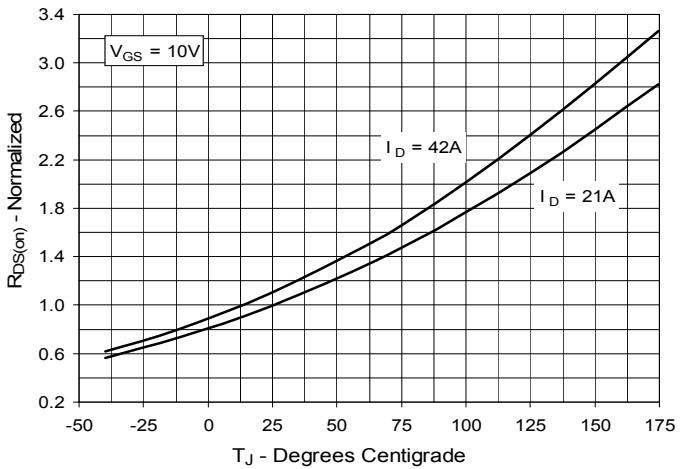
**Fig. 5.  $R_{DS(on)}$  Normalized to  $I_D = 21A$  Value  
vs. Drain Current**



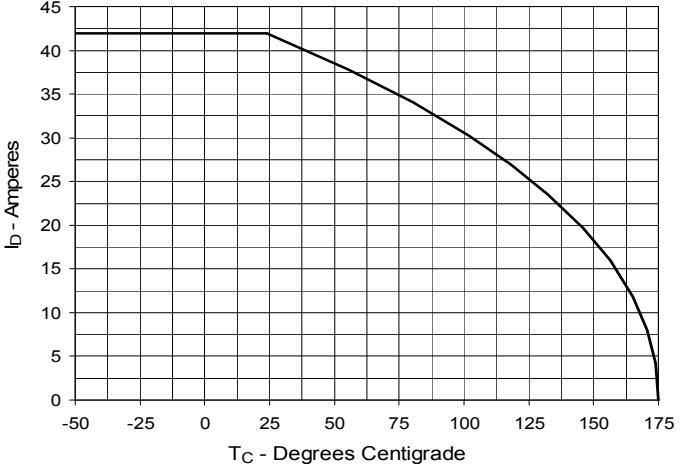
**Fig. 2. Extended Output Characteristics  
@ 25°C**

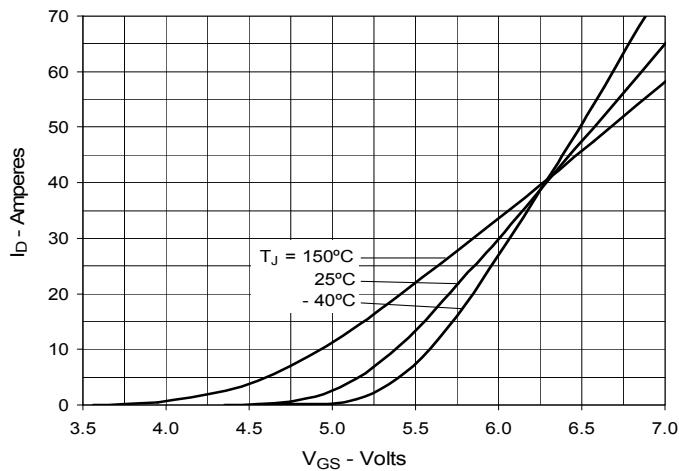
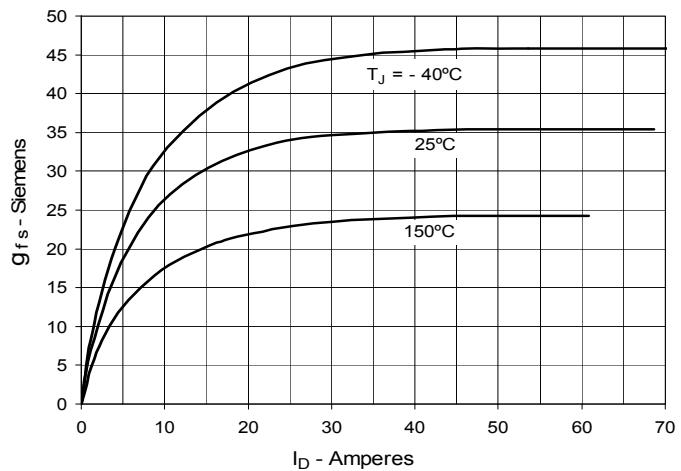
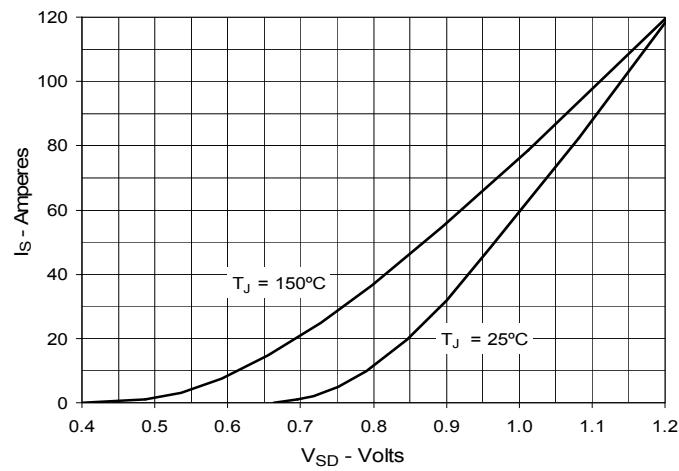
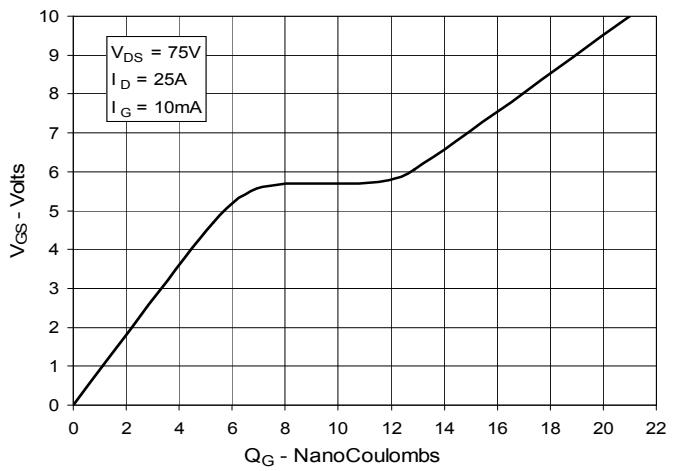
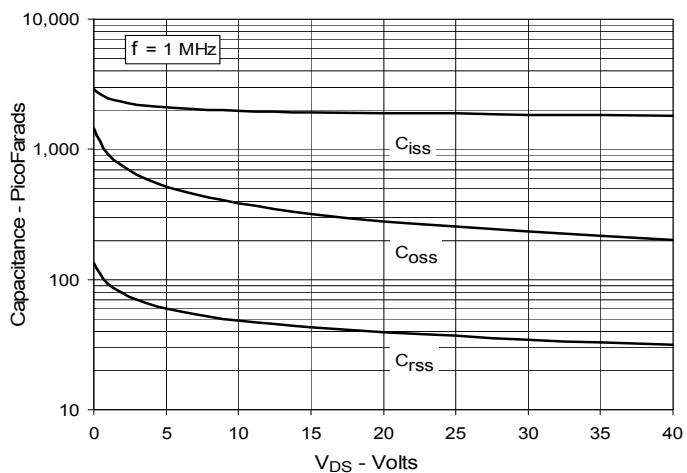
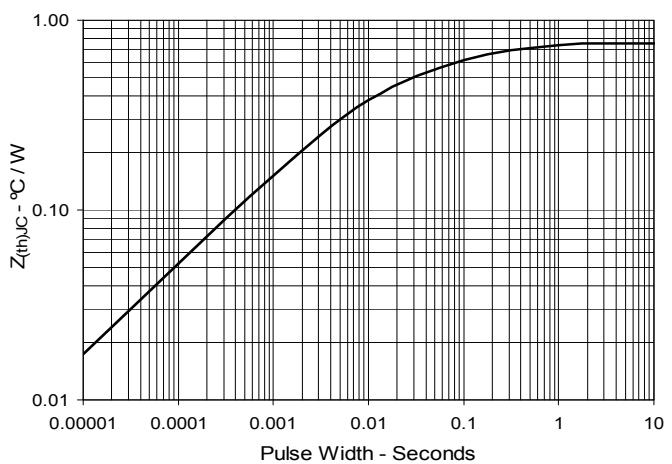


**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 21A$  Value  
vs. Junction Temperature**



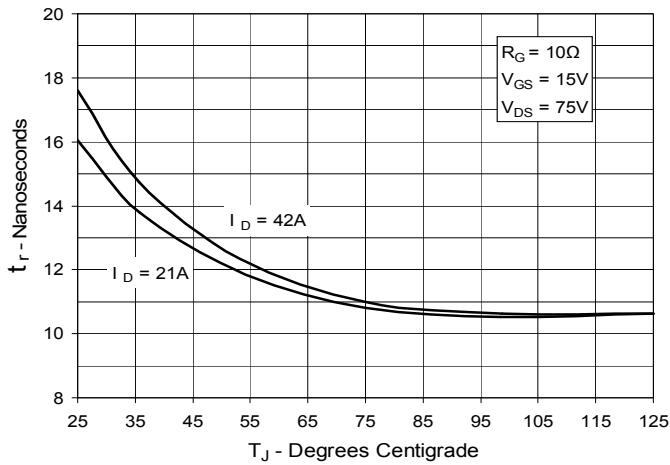
**Fig. 6. Drain Current vs. Case Temperature**



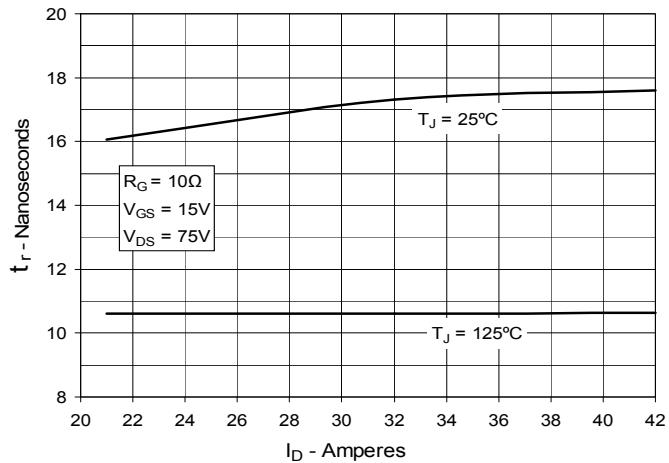
**Fig. 7. Input Admittance****Fig. 8. Transconductance****Fig. 9. Forward Voltage Drop of Intrinsic Diode****Fig. 10. Gate Charge****Fig. 11. Capacitance****Fig. 12. Maximum Transient Thermal Impedance**

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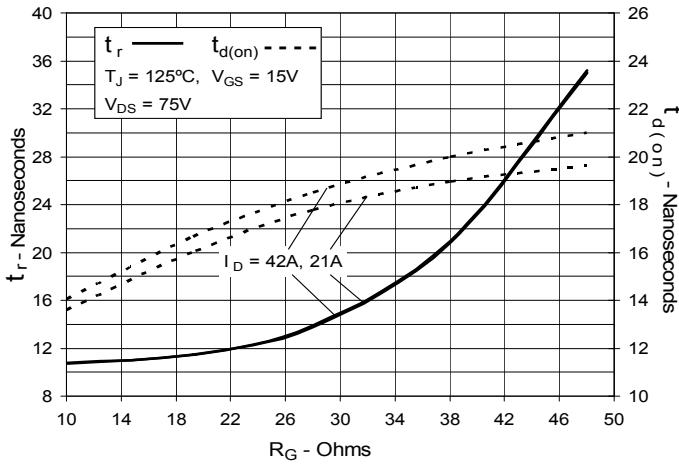
**Fig. 13. Resistive Turn-on  
Rise Time vs. Junction Temperature**



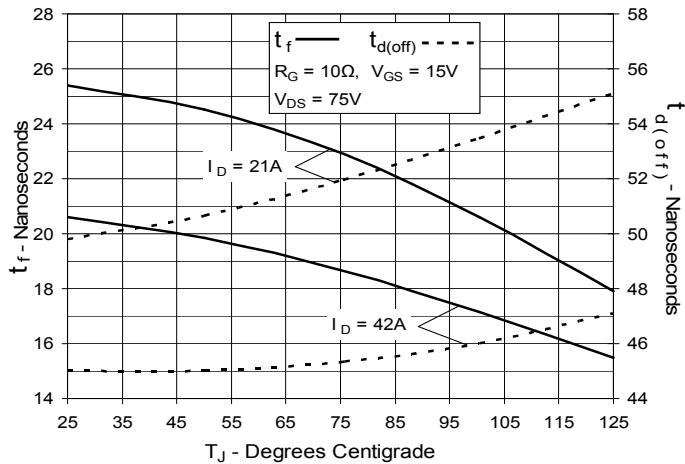
**Fig. 14. Resistive Turn-on  
Rise Time vs. Drain Current**



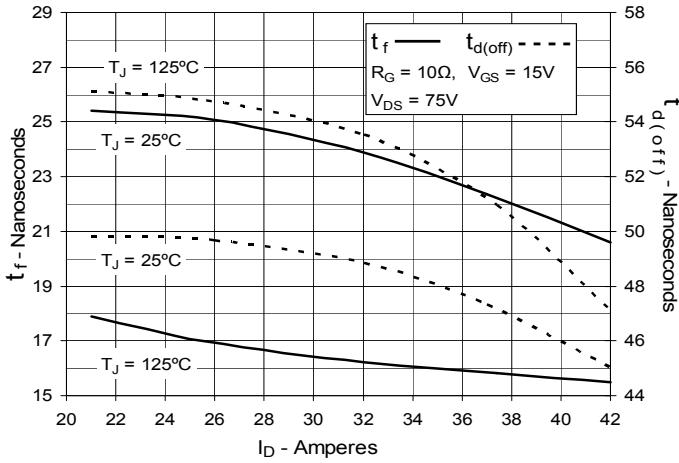
**Fig. 15. Resistive Turn-on  
Switching Times vs. Gate Resistance**



**Fig. 16. Resistive Turn-off  
Switching Times vs. Junction Temperature**



**Fig. 17. Resistive Turn-off  
Switching Times vs. Drain Current**



**Fig. 18. Resistive Turn-off  
Switching Times vs. Gate Resistance**

